

High Power Infrared Emitter (850 nm) Version 1.4

SFH 4232



Features:

- IR lightsource with high efficiency
- Low thermal resistance (Max. 9 K/W)
- Centroid wavelength 850 nm
- Superior Corrosion Robustness (see chapter package outlines)
- The product qualification test plan is based on the guidelines of AEC-Q101-REV-C, Stress Test Qualification for Automotive Grade Discrete Semiconductors.
- **Package:** SMT package

Applications

- Infrared Illumination for cameras
- Surveillance systems
- Machine vision systems

Notes

Depending on the mode of operation, these devices emit highly concentrated non visible infrared light which can be hazardous to the human eye. Products which incorporate these devices have to follow the safety precautions given in IEC 60825-1 and IEC 62471.

Ordering Information

Type:	Total Radiant Flux Φ_e [mW] $I_F = 1A, t_p = 10\text{ ms}$	Ordering Code
SFH 4232	530 (≥ 320)	Q65110A8754

Note: Measured with integrating sphere.

Maximum Ratings ($T_A = 25\text{ °C}$)

Parameter	Symbol	Values	Unit
Operation and storage temperature range	$T_{op}; T_{stg}$	-40 ... 125	°C
Junction temperature	T_j	145	°C
Reverse voltage	V_R	1	V
Forward current	I_F	1000	mA
Surge current ($t_p \leq 200\ \mu\text{s}$, $D = 0$)	I_{FSM}	5	A
Power consumption	P_{tot}	1800	mW
ESD withstand voltage (acc. to ANSI/ ESDA/ JEDEC JS-001 - HBM)	V_{ESD}	2	kV
Thermal resistance junction - soldering point	R_{thJS}	9	K / W

Characteristics ($T_A = 25\text{ °C}$)

Parameter	Symbol	Values	Unit
Peak wavelength ($I_F = 1\text{ A}$, $t_p = 10\text{ ms}$)	λ_{peak}	860	nm
Centroid wavelength ($I_F = 1\text{ A}$, $t_p = 10\text{ ms}$)	$\lambda_{centroid}$	850	nm
Spectral bandwidth at 50% of I_{max} ($I_F = 1\text{ A}$, $t_p = 10\text{ ms}$)	$\Delta\lambda$	30	nm
Half angle	φ	± 60	°
Dimensions of active chip area	L x W	1 x 1	mm x mm
Rise and fall times of I_e (10% and 90% of $I_{e,max}$) ($I_F = 5\text{ A}$, $R_L = 50\ \Omega$)	t_r / t_f	7 / 14	ns
Forward voltage ($I_F = 1\text{ A}$, $t_p = 100\ \mu\text{s}$)	V_F	1.5 (≤ 1.8)	V
Forward voltage ($I_F = 5\text{ A}$, $t_p = 100\ \mu\text{s}$)	V_F	2 (≤ 2.9)	V
Radiant intensity ($I_F = 1\text{ A}$, $t_p = 100\ \mu\text{s}$)	$I_{e, typ}$	180	mW/sr
Temperature coefficient of I_e or Φ_e ($I_F = 1\text{ A}$, $t_p = 10\text{ ms}$)	TC_I	-0.3	% / K
Temperature coefficient of V_F ($I_F = 1\text{ A}$, $t_p = 10\text{ ms}$)	TC_V	-1	mV / K
Temperature coefficient of wavelength ($I_F = 1\text{ A}$, $t_p = 10\text{ ms}$)	$TC_{\lambda, centroid}$	0.3	nm / K

Grouping ($T_A = 25\text{ °C}$)

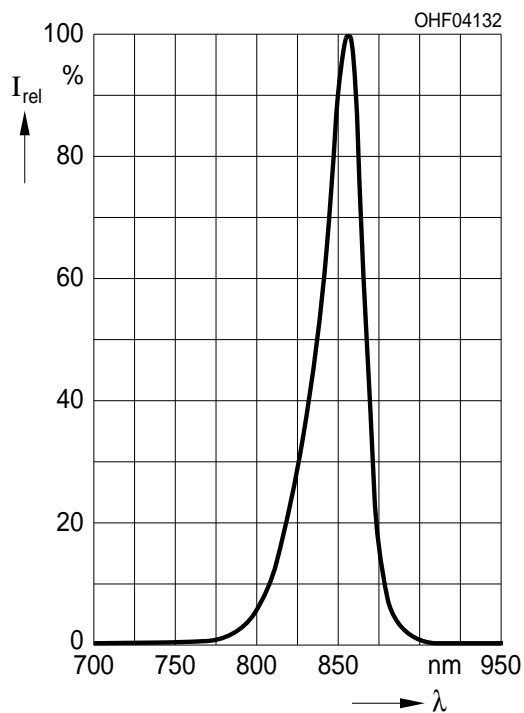
Group	Min Total Radiant Flux	Max Total Radiant Flux
	$I_F = 1\text{ A}, t_p = 10\text{ ms}$ $\Phi_{e\text{ min}} [\text{mW}]$	$I_F = 1\text{ A}, t_p = 10\text{ ms}$ $\Phi_{e\text{ max}} [\text{mW}]$
SFH4232 - CB	320	500
SFH4232 - DA	400	630
SFH4232 - DB	500	800

Note: Measured with integrating sphere.

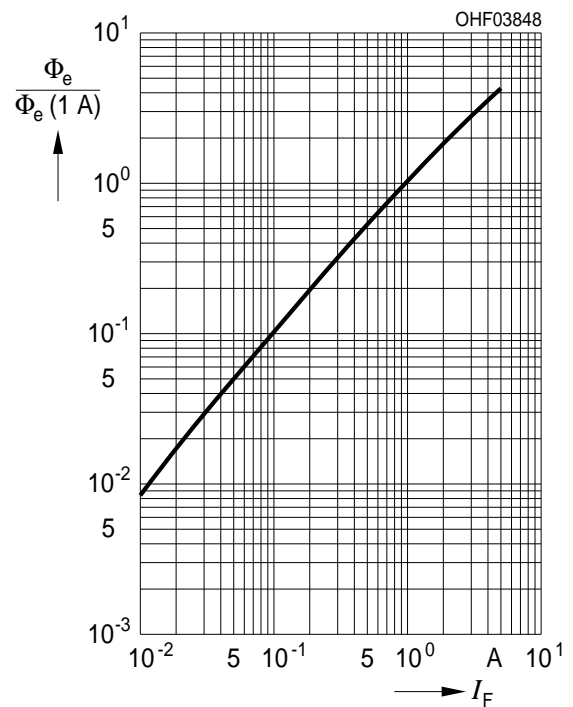
Only one group in one package unit (variation lower 1.6:1)

Relative Spectral Emission ^{1) page 12}

$$I_{\text{rel}} = f(\lambda), T_A = 25\text{ °C}$$

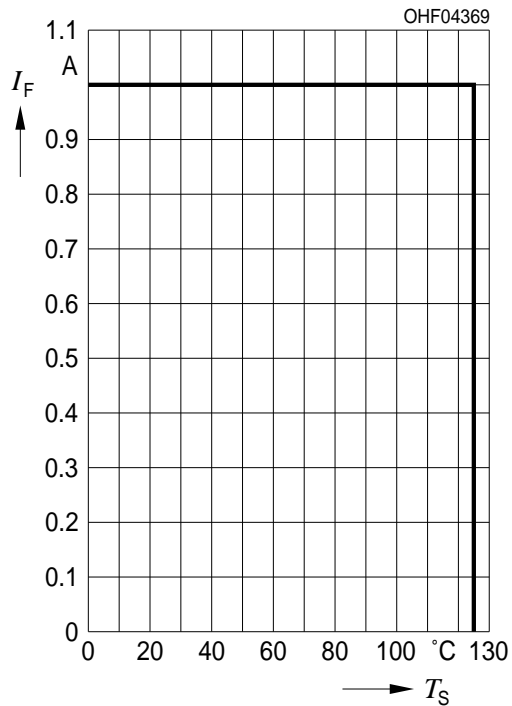
Relative Total Radiant Flux ^{1) page 12}

$$\Phi_e / \Phi_e(1\text{ A}) = f(I_F), T_A = 25\text{ °C}, \text{ Single pulse, } t_p = 100\mu\text{s}$$



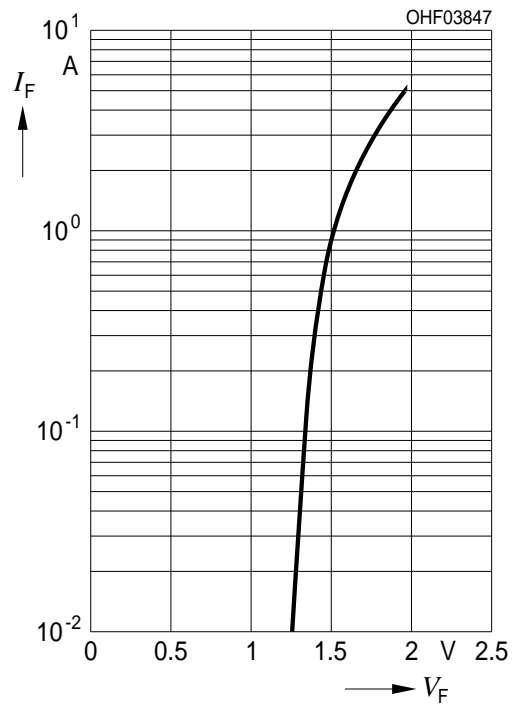
Max. Permissible Forward Current

$I_F = f(T_S), R_{thJS} = 9 \text{ K/W}$



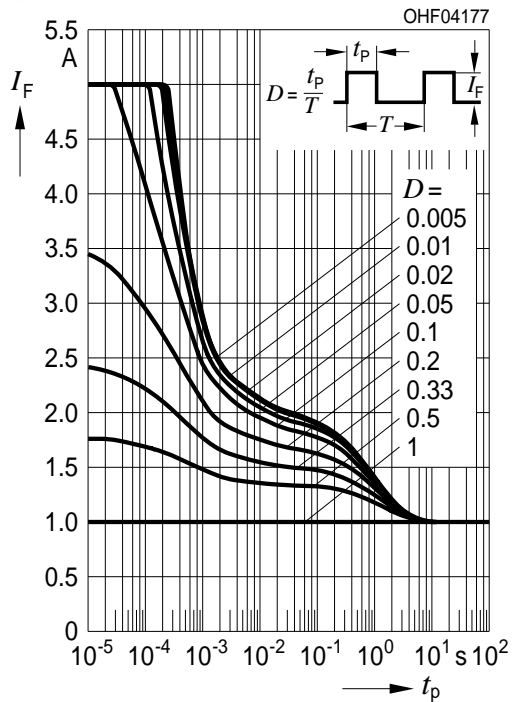
Forward Current ^{1) page 12}

$I_F = f(V_F), \text{ single pulse, } t_p = 100 \mu\text{s}, T_A = 25^\circ\text{C}$



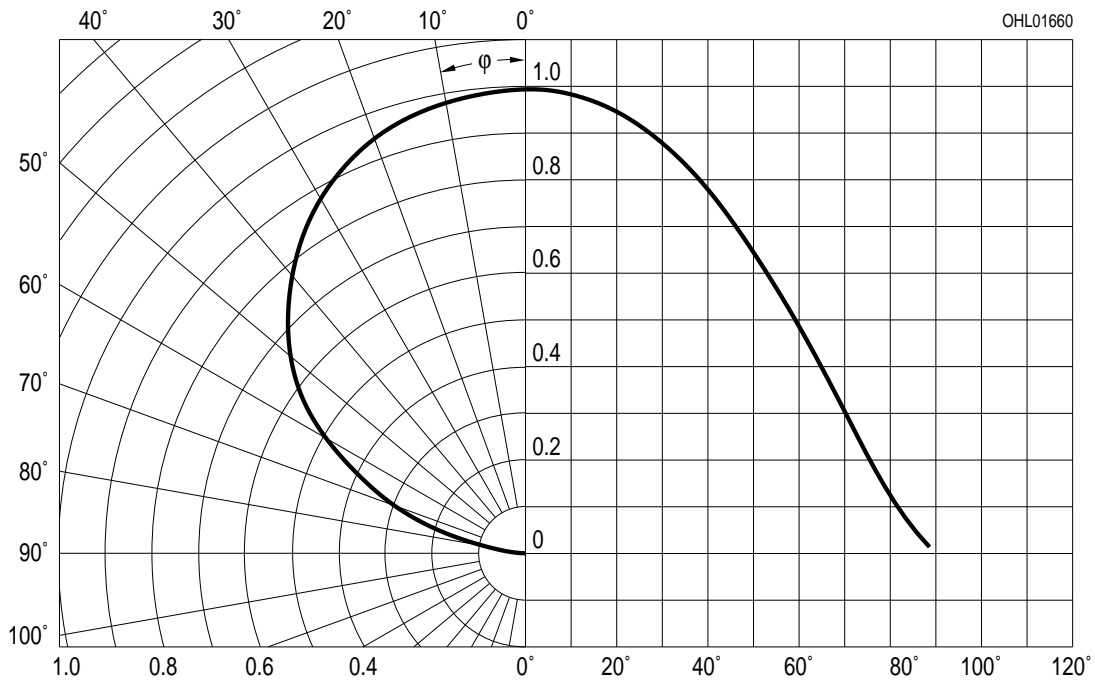
Permissible Pulse Handling Capability

$I_F = f(t_p), T_S = 85^\circ\text{C}, \text{ duty cycle } D = \text{parameter}$

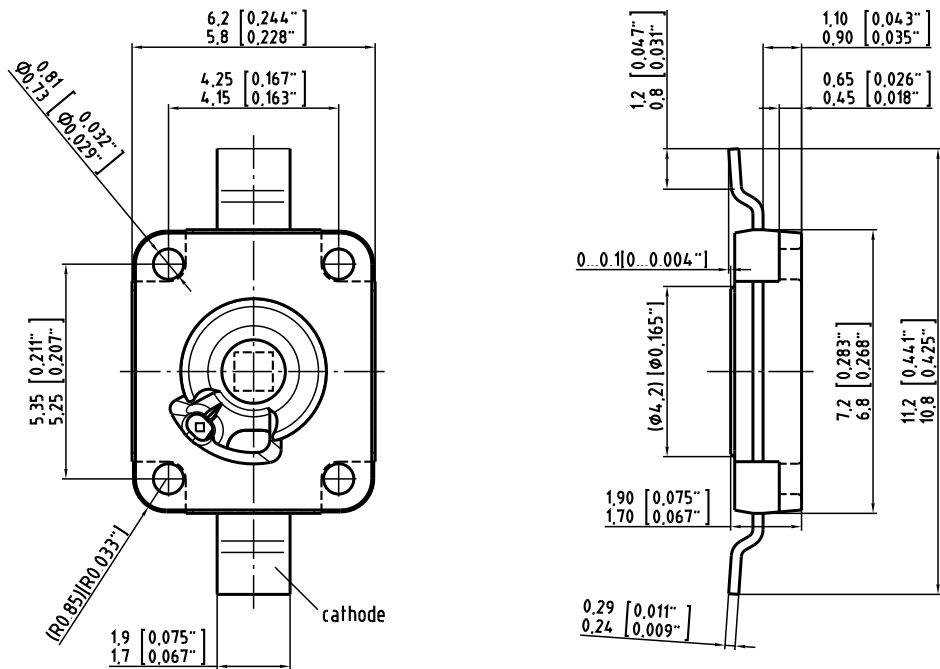


Radiation Characteristics ^{1) page 12}

$I_{rel} = f(\phi), T_A = 25^\circ C$



Package Outline



C67062-A0007-A2-02

Dimensions in mm (inch).

Cathode mark on the bottom side

Note:

Corrosion robustness better than EN 60068-2-60 (method 4): with enhanced corrosion test: 40°C / 90%rh / 15ppm H₂S / 336h

Type:

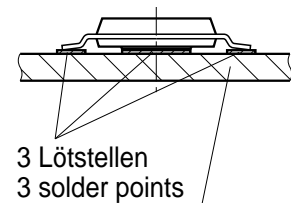
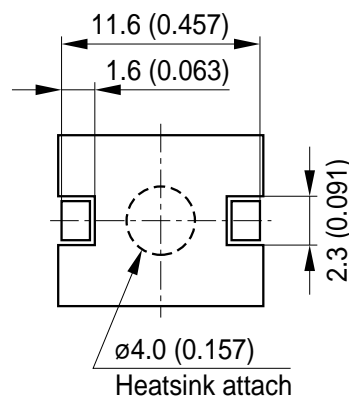
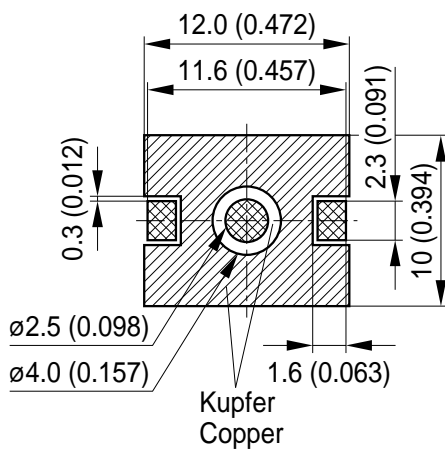
SFH 4232

Package




Platinum Dragon

Approximate Weight:

0.2 g

Recommended Solder Pad

Thermisch optimiertes PCB
Thermal enhanced PCB

-  Lötstopplack
Solder resist
-  Lötpasten Schablone
Solder paste stencil
-  Bare Copper
Freies Kupfer

Dimensions in mm (inch).

Attention

Anode and Heatsink are electrically connected

OHAY0681

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020D.01



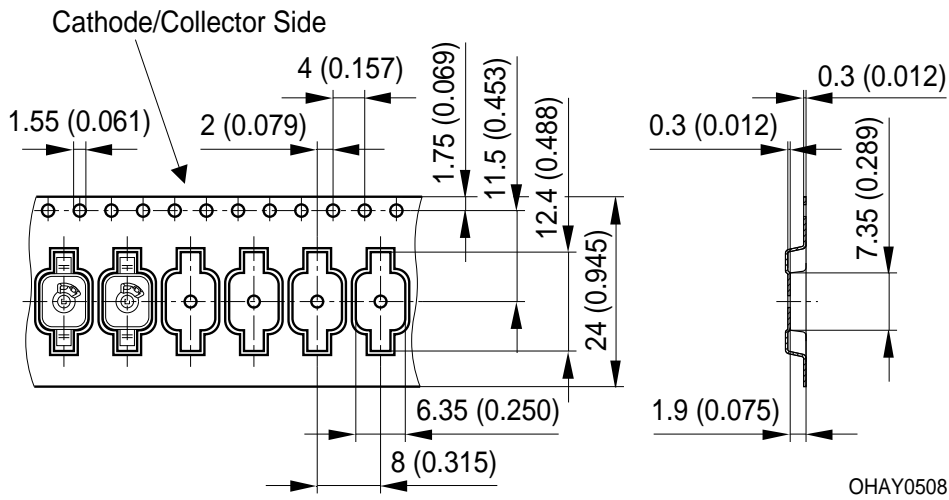
OHA04612

Profile Feature Profil-Charakteristik	Symbol Symbol	Pb-Free (SnAgCu) Assembly			Unit Einheit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L	217			$^{\circ}\text{C}$
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	$^{\circ}\text{C}$
Time within 5 °C of the specified peak temperature $T_p - 5\text{ K}$	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

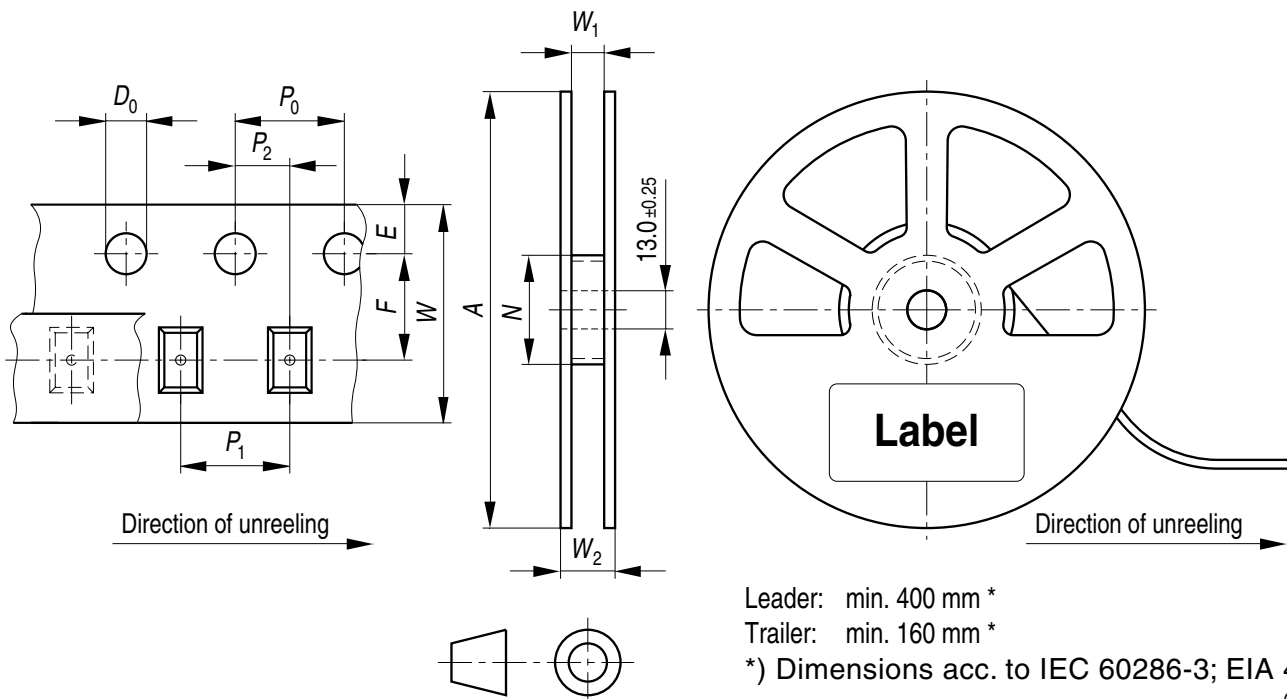
Taping



Dimensions in mm (inch).

Tape and Reel

24 mm tape with 800 pcs. on Ø 180 mm reel



Tape dimensions [mm]

W	P ₀	P ₁	P ₂	D ₀	E	F
24 + 0.3 / - 0.1	4 ± 0.1	8 ± 0.1 or 12 ± 0.1	2 ± 0.1	1.5 ± 0.1	1.75 ± 0.1	11.5 ± 0.05

Reel dimensions [mm]

A	W	N _{min}	W ₁	W _{2max}
180	24	60 / 100	24.4 + 2	30.4

Barcode-Product-Label (BPL)



Dry Packing Process and Materials



Note:

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card. Regarding dry pack you will find further information in the internet. Here you will also find the normative references like JEDEC.

Transportation Packing and Materials



Dimensions of transportation box in mm

Width	Length	Height
195 ± 5	195 ± 5	42 ± 5

Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.

Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the Internet.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Components used in life-support devices or systems must be expressly authorized for such purpose!

Critical components* may only be used in life-support devices** or systems with the express written approval of OSRAM OS.

*) A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

**) Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered.

Glossary

- ¹⁾ **Typical Values:** Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

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EU RoHS and China RoHS compliant product



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JONHON

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«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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